



RS1GT126 Single Bus Buffer Gate With 3-State Output

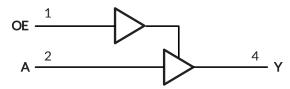
1 FEATURES

- Operating Voltage Range: 2V to 5.5V
- Low Power Consumption: 1μA (Max)
- Operating Temperature Range: -40°C to +125°C
- Inputs Are TTL-Voltage Compatible
- ±32mA Output Drive at V_{CC}=5.0V
- Latch-up Performance Exceeds 100mA
- Micro SIZE PACKAGES: SOT23-5, SC70-5(SOT353)

2 APPLICATIONS

- AV Receiver
- Cable Modem Termination Systems
- Digital Picture Frame (DPF)
- High-Speed Data Acquisition and Generation
- Motor Controls: High-Voltage
- Personal Navigation Device (GPS)
- Portable Media Player
- Video Communication Systems

Simplified Schematic



3 DESCRIPTIONS

The single buffer is designed for 2V to $5.5V\ V_{CC}$ operation. The RS1GT126 device is single line driver with 3-state output. The output is disabled when the output-enable input is low.

This device is fully specified for partial-power-down applications using loff. The loff circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pulldown resistor, the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The RS1GT126 is available in Green SOT23-5 and SC70-5(SOT353) packages. It operates over an ambient temperature range of -40°C to +125°C.

Device Information (1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)
	SOT23-5(5)	2.92mm×1.60mm
RS1GT126	SC70-5 (SOT353) (5)	2.10mm×1.25mm

⁽¹⁾ For all available packages, see the orderable addendum at the end of the data sheet.

FUNCTION TABLE

INP	OUTPUT	
OE	Α	Υ
Н	Н	Н
Н	L	L
L	Х	Z

H=HIGH Logic Level L =LOW Logic Level X=Don't Care

 $Z{=}High{-}impedance\ OFF{-}state$



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4 Revision HistoryNote: Page numbers for previous revisions may different from page numbers in the current version.

Version	Change Date	Change Item	
A.1	2023/11/08	Initial version completed	



5 PACKAGE/ORDERING INFORMATION (1)

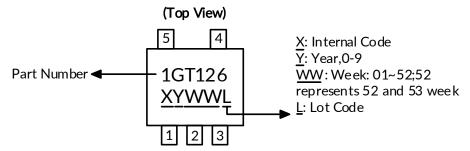
PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING (2)	MSL ⁽³⁾	PACKAGE OPTION
	RS1GT126XF5	-40°C ~+125°C	SOT23-5	1GT126	MSL3	Tape and Reel,3000
RS1GT126	RS1GT126XC5	-40°C ~+125°C	SC70-5 (SOT353)	1GT126	MSL3	Tape and Reel,3000

NOTE:

- (1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.
- (2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.
- (3) MSL, The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications.

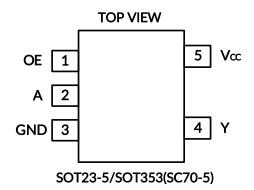
Marking Information

(1) SOT23-5, SC70-5(SOT353)





6 PIN CONFIGURATIONS



PIN DESCRIPTION

PIN	NANAF	I/O TYPE (1)	FUNCTION				
SOT23-5/SOT353(SC70-5)	NAME	I/O I YPE (2)	FUNCTION				
1	OE	I	OE Enable/Input				
2	Α	I	A Input				
3	GND	1	Ground Pin				
4	Y	0	Y Output				
5	V_{CC}	-	Power Pin				

⁽¹⁾ I=input, O=output.



7 Specifications

7.1 Absolute Maximum Ratings (1)

over operating free-air temperature range (unless otherwise noted) (1) (2)

			MIN	MAX	UNIT
V _{CC}	V _{CC} Supply voltage range				٧
Vı	Input voltage range (2)		-0.5	6.5	٧
Vo	Voltage range applied to any output in the high-impedan	ce or power-off state ⁽²⁾	-0.5	6.5	V
Vo	Voltage range applied to any output in the high or low st	ate ⁽²⁾⁽³⁾	-0.5	Vcc+0.5	V
lıĸ	Input clamp current V _I <0			-50	mA
Іок	Output clamp current Vo<0			-50	mA
lo	Continuous output current			±50	mA
	Continuous current through V _{CC} or GND			±100	mA
θιΑ	Daglage thermal impedance (4)	SOT23-5		230	°C/W
OJA	Package thermal impedance ⁽⁴⁾ SOT353/(SC70-5)			380	C/VV
٦	T _J Junction temperature ⁽⁵⁾				°C
Tstg	T _{stg} Storage temperature				°C

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of V_{CC} is provided in the Recommended Operating Conditions table.
- (4) The package thermal impedance is calculated in accordance with JESD-51.
- (5) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} T_A) / R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.

7.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

			VALUE	UNIT
		Human-body model (HBM), MIL-STD-883K METHOD 3015.9	±2000	
V(ESD)	Electrostatic discharge	Charged-device model (CDM), ANSI/ESDA/JEDEC JS-002-2018	±1000	V
		Machine Model (MM), JESD22-A115C (2010)	±200	



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

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8 ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (TYP values are at T_A = +25°C, unless otherwise noted.) (1)

8.1 Recommended Operating Conditions

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
Supply voltage	Vcc	Operating	2	5.5	V
		V _{CC} =2V	1		
High-level input voltage	V_{IH}	V _{CC} =3.3V	1.5		V
		V _{CC} =4.5V to 5.5V	2		
		Vcc=2V		0.3	
Low-level input voltage	V_{IL}	V _{CC} =3.3V		0.55	V
		V _{CC} =4.5V to 5.5V		0.8	
Input voltage	Vı		0	5.5	V
Output voltage	Vo		0	Vcc	V
Input transition rise or fall	t _r , t _f	V _{CC} =2.0V to 5.5V		5	ns/V
Operating temperature	T _A		-40	125	°C

⁽¹⁾ All unused inputs of the device must be held at Vcc or GND to ensure proper device operation.

8.2 DC Characteristics

PA	RAMETER	TEST CONDITIONS	Vcc	TEMP	MIN ⁽²⁾	TYP (3)	MAX ⁽²⁾	UNIT
		I _{OH} = -100μA	2V to 5.5V		V _{CC} -0.1			
		I _{OH} = -8mA	2V		1.2			
	V_{OH}	I _{OH} = -24mA	3.3V	- Full	1.9			V
	V OH		4.5V	Full	2.4			V
		I _{OH} = -32mA	5V		2.3			
			5.5V		3.8			
		I _{OL} = 100μA	2V to 5.5V				0.1	
		I _{OL} = 8mA	2V				0.45	
	V_{OL}	I _{OL} = 24mA	3.3V	Full			0.3	V
	VOL		4.5V				0.4	
		I _{OL} = 32mA	5V				0.55	
			5.5V				0.55	
1.	A or OE	V _I =5.5V or GND	0V to 5.5V	+25°C		±0.1	±1	
l _l	inputs	V -3.3V OF GND	00 to 5.50	Full			±5	μΑ
	1	\\.or\\E E\\	0V	+25°C		±0.1	±1	
	I _{off} V _I or V _O =5.5V		OV	Full			±10	μΑ
lcc		V _I =5.5V or GND, I _O =0	2V to 5.5V	+25°C		0.1	1	۸
		V -3.3V OI GIND, 10-0	ZV 10 3.3V	Full			10	μΑ
IccT One input at Vcc-3.4V, Other inputs at Vcc or GND		5.5V	Full			500	μΑ	
Ci (Inp	ut Capacitance)	V _{CC} =0V, f = 10MHz	0V	+25°C		4		рF

⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

⁽²⁾ This parameter is ensured by design and/or characterization and is not tested in production.

⁽³⁾ Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.



8.3 AC Characteristics

PAR	AMETER	SYMBOL	TEST CO	ONDITIONS	MIN ⁽²⁾	TYP (3)	MAX ⁽²⁾	UNIT
			V _{CC} =2.0V±0.2V	C _L =30pF, R _L =500Ω		15.5		
Propag	ation Delay	t_{pd}	V _{CC} =3.3V±0.3V	C _L =50pF, R _L =500Ω		9.7		ns
			V _{CC} =5.0V±0.5V	C _L =50pF, R _L =500Ω		7.5		
			V _{CC} =2.0V±0.2V	C _L =30pF, R _L =500Ω		10.8		
Ena	ble Time	t_{en}	V _{CC} =3.3V±0.3V	C _L =50pF, R _L =500Ω		7.4		ns
			V _{CC} =5.0V±0.5V	C _L =50pF, R _L =500Ω		6.04		
			V _{CC} =2.0V±0.2V	C _L =30pF, R _L =500Ω		13.6		
Disa	able Time	t_{dis}	V _{CC} =3.3V±0.3V	C _L =50pF, R _L =500Ω		9.7		ns
			V _{CC} =5.0V±0.5V	C _L =50pF, R _L =500Ω		7.7		
Power	Output enabled					40		_
dissipation capacitance	Output disabled	C_pd	V _{CC} =5V	f=10MHz		4		pF

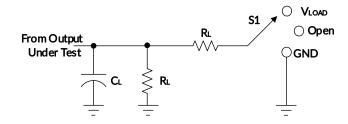
⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

⁽²⁾ This parameter is ensured by design and/or characterization and is not tested in production.

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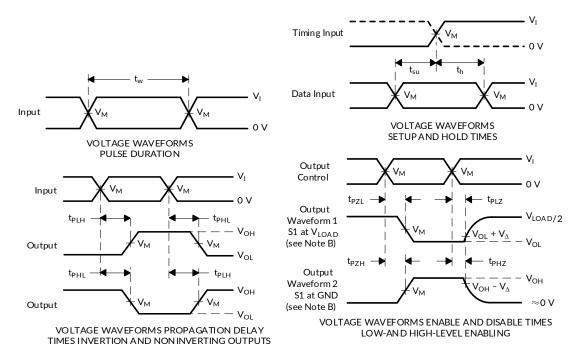


9 Parameter Measurement Information



TEST	S1
tplH/tpHL	Open
t _{PLZ} /t _{PZL}	V_{LOAD}
tpHZ/tpZH	GND

V cc	INPUTS		V _M	V _{LOAD}	CL	D.	VΔ
	Vı	t _r /t _f	VM	V LOAD	CL	RL	VΔ
2.0V±0.2V	Vcc	≤2ns	Vcc/2	2 x Vcc	30pF	500Ω	0.15V
3.3V±0.3V	3V	≤2.5ns	1.5V	6V	50pF	500Ω	0.3V
5V±0.5V	Vcc	≤2.5ns	Vcc/2	2 x Vcc	50pF	500Ω	0.3V



NOTES: A. C_L includes probe and jig capacitance.

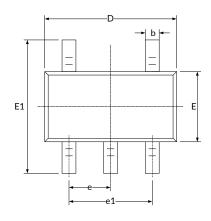
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_0 = 50 Ω .
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as $t_{\text{pd}}.$
- H. All parameters and waveforms are not applicable to all devices.

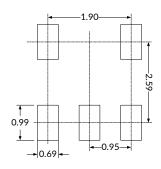
Figure 1. Load Circuit and Voltage Waveforms

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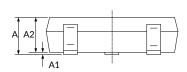


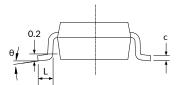
10 PACKAGE OUTLINE DIMENSIONS SOT23-5 (3)





RECOMMENDED LAND PATTERN (Unit: mm)





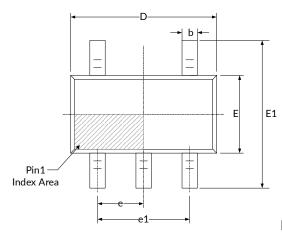
Symbol	Dimensions I	n Millimeters	Dimensions In Inches			
	Min	Max	Min	Max		
A ⁽¹⁾	1.050	1.250	0.041	0.049		
A1	0.000	0.100	0.000	0.004		
A2	1.050	1.150	0.041	0.045		
b	0.300	0.500	0.012	0.020		
С	0.100	0.200	0.004	0.008		
D ⁽¹⁾	2.820	3.020	0.111	0.119		
E (1)	1.500	1.700	0.059	0.067		
E1	2.650	2.950	0.104	0.116		
e	0.950(BSC) (2)	0.037(BSC) (2)			
e1	1.800	2.000	0.071	0.079		
L	0.300	0.600	0.012	0.024		
θ	0°	8°	8° 0°			

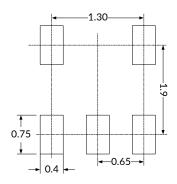
NOTE:

- 1. Plastic or metal protrusions of 0.15mm maximum per side are not included.
- BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
 This drawing is subject to change without notice.

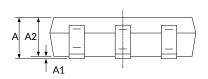


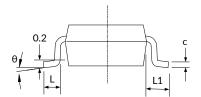
SOT353(SC70-5)(3)





RECOMMENDED LAND PATTERN (Unit: mm)





Symbol	Dimensions I	n Millimeters	Dimensions In Inches			
	Min	Мах	Min	Max		
A (1)	0.900	1.100	0.035	0.043		
A1	0.000	0.100	0.000	0.004		
A2	0.900	1.000	0.035	0.039		
b	0.150	0.350	0.006	0.014		
С	0.080	0.150	0.003	0.006		
D (1)	2.000	2.200	0.079	0.087		
E ⁽¹⁾	1.150	1.350	0.045	0.053		
E1	2.150	2.450	2.450 0.085			
е	0.650(BSC) (2)	0.026(BSC) (2)			
e1	1.300(BSC) (2)		0.051(BSC) (2)			
L	0.260	0.460	0.460 0.010			
L1	0.5	0.525)21		
θ	0°	8°	0°	8°		

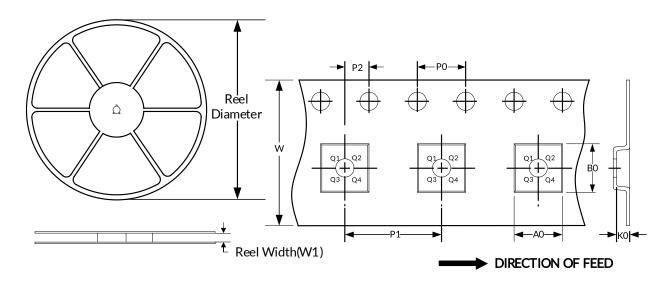
NOTE:

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- 2. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
- 3. This drawing is subject to change without notice.



11 TAPE AND REEL INFORMATION REEL DIMENSIONS

TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width(mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT353(SC70-5)	7"	9.5	2.25	2.55	1.20	4.0	4.0	2.0	8.0	Q3
SOT23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3

NOTE:

- 1. All dimensions are nominal.
- 2. Plastic or metal protrusions of 0.15mm maximum per side are not included.



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